

NOT RECOMMENDED FOR NEW DESIGN -**USE DGD05473**



HIGH FREQUENCY HIGH-SIDE AND LOW-SIDE GATE DRIVER IN W-DFN3030-10

Description

The DGD0547 is a high-frequency gate driver capable of driving Nchannel MOSFETs. The floating high-side driver is rated up to 50V.

The DGD0547 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with MCUs. UVLO for high-side and low-side will protect a MOSFET with loss of supply. To protect MOSFETs, cross conduction prevention logic prevents the HO and LO outputs from being on at the same time.

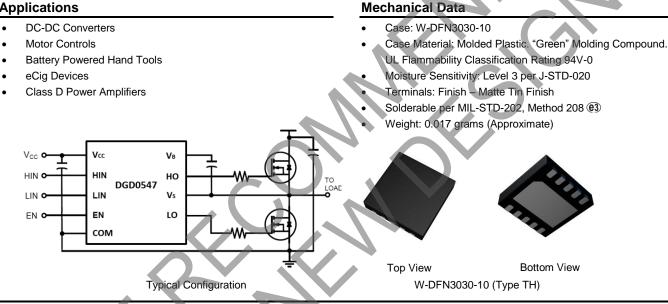
Fast and well-matched propagation delays allow a higher switching frequency, enabling a smaller, more compact power switching design, using smaller associated components. To minimize space an internal bootstrap diode is included. The DGD0547 is offered in the W-DFN3030-10 (Type TH) package and operates over an extended -40°C to +125°C temperature range.

Applications

Battery Powered Hand Tools

Features

- 50V Floating High-Side Driver
- Drives Two N-channel MOSFETs in a Half-Bridge Configuration
- 1.5A Source / 2.5A Sink Output Current Capability
- Internal Bootstrap Diode Included
- Undervoltage Lockout for High-Side and Low-Side Drivers
- Delay Matching Maxmimum of 5ns
- Propagation Delay Typical of 20ns
- Logic Input (HIN, LIN and EN) 3.3V Capability
- Ultra Low Standby Currents (<1µA) •
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony free. "Green" Device (Note 3)



Ordering Information (Note 4)

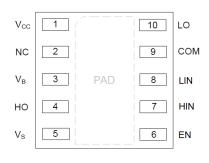
Product	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD0547FN-7	DGD0547	7	8	3,000
 See https://www.di Lead-free. Halogen- and Antir <1000ppm antimor For packaging details 	odes.com/quality/lead-free/ for mo mony-free "Green" products are d by compounds. ails, go to our website at https://we	5/EC (RoHS), 2011/65/EU (RoHS ore information about Diodes Inco efined as those which contain <90 ww.diodes.com/design/support/pa	rporated's definitions of Halogen- 0ppm bromine, <900ppm chlorine	and Antimony-free, "Green" and
Marking Informatio	on 🔹			



DGD0547 = Product Type Marking Code YY = Year (ex: 19 = 2019) WW = Week (01 to 53)



Pin Diagrams

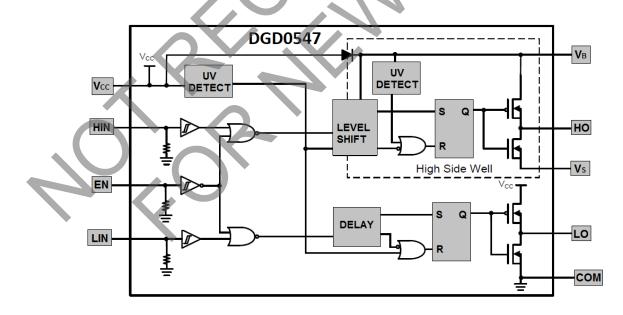


Top View: W-DFN3030-10 (Type TH)

Pin Descriptions

Pin Number	Pin Name	Function
1	V _{CC}	Low-Side and Logic Supply
2	NC	No Connect (No Internal Connection)
3	VB	High-Side Floating Supply
4	HO	High-Side Gate Drive Output
5	Vs	High-Side Floating Supply Return
6	EN	Logic Input Enable, a Logic Low turns off Gate Driver
7	HIN	Logic Input for High-Side Gate Driver, in Phase with HO
8	LIN	Logic Input for Low-Side Gate Driver, in Phase with LO
9	COM	Low-Side and Logic Return
10	LO	Low-Side Gate Drive Output
PAD	Substrate	Connect to COM on PCB

Functional Block Diagram





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Positive Supply Voltage	VB	-0.3 to +60	V
High-Side Floating Negative Supply Voltage	Vs	V _B -14 to V _B +0.3	V
High-Side Floating Output Voltage	V _{HO}	V _S -0.3 to V _B +0.3	V
Offset Supply Voltage Transient	dV _S / dt	50	V/ns
Logic and Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +14	V
Low-Side Output Voltage	V _{LO}	-0.3 to V _{CC} +0.3	V
Logic Input Voltage (HIN, LIN and EN)	V _{IN}	-0.3 to V _{CC} +0.3	V
Bootstrap Diode Current (Pulsed <10µs)	I _{BD}	1	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol	Value	Unit
PD	0.4	W
R _{θJA}	64	°C/W
R _{θJC}	42	°C/W
TJ	+150	
TL	+300	°C
T _{STG}	-55 to +150	
	P _D R _{θJA} R _{θJC} TJ TL	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High-Side Floating Supply	VB	Vs + 5	Vs + 14	V
High-Side Floating Supply Offset Voltage	Vs	(Note 6)	50 (Note 7)	V
High-Side Floating Output Voltage	V _{HO}	Vs	VB	V
Logic and Low Side Fixed Supply Voltage	Vcc	5	14	V
Low-Side Output Voltage	VLO	0	V _{CC}	V
Logic Input Voltage (HIN, LIN and EN)	Vin	0	5	V
Ambient Temperature	T _A	-40	+125	C°

Notes: 6. Logic operation for V_S of -5V to +50V.

7. Provided V_B doesn't exceed absolute maximum rating of 60V.



DC Electrical Characteristics ($V_{CC} = V_{BS} = 12V$, COM = $V_S = 0V$, $@T_A = +25^{\circ}C$, unless otherwise specified.) (Note 8)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage	VIH	2.4	_	-	V	-
Logic "0" Input Voltage	VIL	-	-	0.8	V	—
Enable Logic "1" Input Voltage	V _{ENIH}	1.6	-	-	V	—
Enable Logic "0" Input Voltage	V _{ENIL}	-	-	0.7	V	-
Input Voltage Hysteresis	VINHYS	-	0.6	-	V	—
Enable Input Voltage Hysteresis	V _{ENINHYS}	-	0.1	-	V	-
High Level Output Voltage, V _{BIAS} - V _O	Vон	-	0.45	0.6	V	I _{O+} = 100mA
Low Level Output Voltage, V _O	V _{OL}	-	0.15	0.22	V	I _{O-} = 100mA
Offset Supply Leakage Current	I _{LK}	-	1	5	μA	$V_B = V_S = 60V$
V _{CC} Shutdown Supply Current	ICCSD	-	0	1	μA	$V_{IN} = 0V \text{ or } 5V, V_{EN} = 0V$
V _{CC} Quiescent Supply Current	Iccq	-	130	200	μA	V _{IN} = 0V or 5V
V _{CC} Operating Supply Current	ICCOP	-	7.3	-	mA	fs = 500 kHz
V _{BS} Quiescent Supply Current	I _{BSQ}	-	40	100	μA	$V_{IN} = 0V \text{ or } 5V$
V _{BS} Operating Supply Current	I _{BSOP}	-	7.3		mA	fs = 500kHz
Logic "1" Input Bias Current	I _{IN+}	-	-	50	μA	$V_{IN} = 5V$
Logic "0" Input Bias Current	I _{IN-}	-	-	5	μA	$V_{IN} = 0V$
Enable Logic "1" Input Bias Current	I _{ENIN+}	-	43	60	μA	$V_{IN} = 5V$
Enable Logic "0" Input Bias Current	I _{ENIN-}	-	0	5	μA	$V_{IN} = 0V$
V _{BS} Supply Undervoltage Positive Going Threshold	V _{BSUV+}	4.1	4.5	4.9	V	-
V _{BS} Supply Undervoltage Negative Going Threshold	V _{BSUV-}	3.6	4.0	4.4	V	-
V _{CC} Supply Undervoltage Positive Going Threshold	V _{CCUV+}	4.1	4.5	4.9	V	-
V _{CC} Supply Undervoltage Negative Going Threshold	Vccuv-	3.6	4.0	4.4	V	-
Output High Short Circuit Pulsed Current	I _{O+}	1.0	1.5	-	A	V _O = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	I _{O-}	1.9	2.5		A	V _O = 15V, PW ≤ 10µs
Forward Voltage of Bootstrap Diode	V _{F1}	-	0.67		V	I _F = 100μA
Forward Voltage of Bootstrap Diode	V _{F2}		1.2	-	V	I _F = 100mA

Note: 8. The V_{IN} and I_{IN} parameters are applicable to the two logic pins: HIN, LIN and EN. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

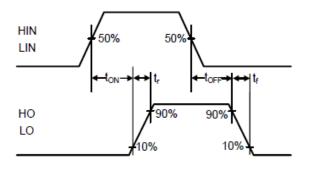
AC Electrical Characteristics (V_{CC} = V_{BS} = 12V, COM = V_S = 0V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	t _{ON}	-	20	35	ns	-
Turn-Off Propagation Delay	toff	-	23	56	ns	$V_S = 50V$
Delay Matching, HO & LO Turn-On	t _{DM}	-	-	5	ns	-
Turn-On Rise Time	t _R	-	16	30	ns	-
Turn-Off Fall Time	tF	-	12	25	ns	-

40,0



Timing Waveforms



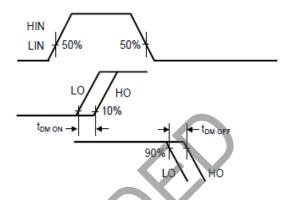
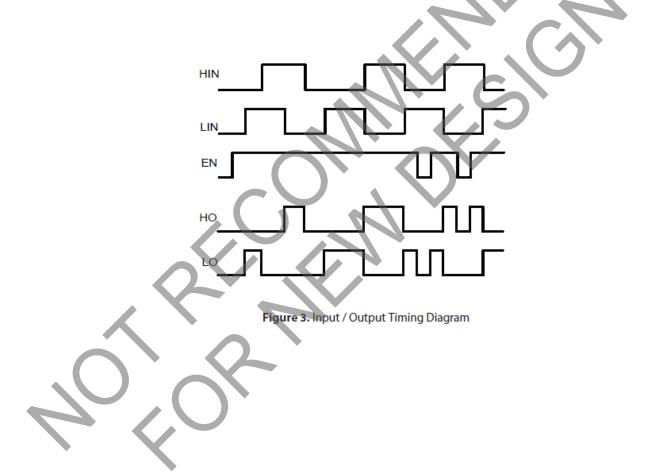


Figure 1. Switching Time Waveform Definitions

Figure 2. Delay Matching Waveform Definitions





Typical Performance Characteristics (@T_A = +25°C, unless otherwise specified.)

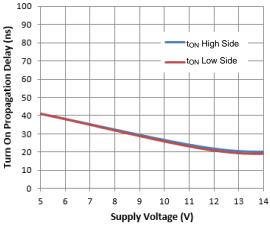


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

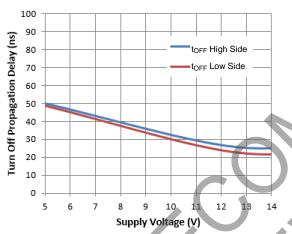


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

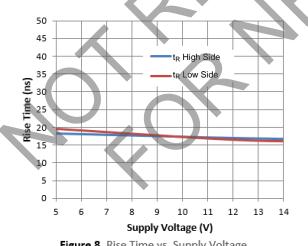


Figure 8. Rise Time vs. Supply Voltage

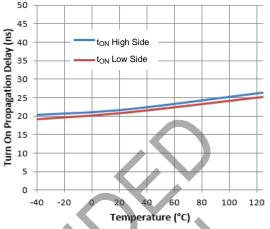
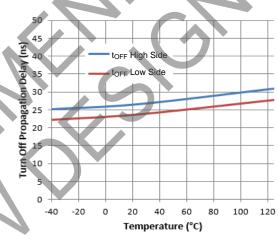
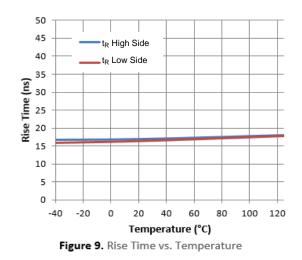


Figure 5. Turn-on Propagation Delay vs. Temperature

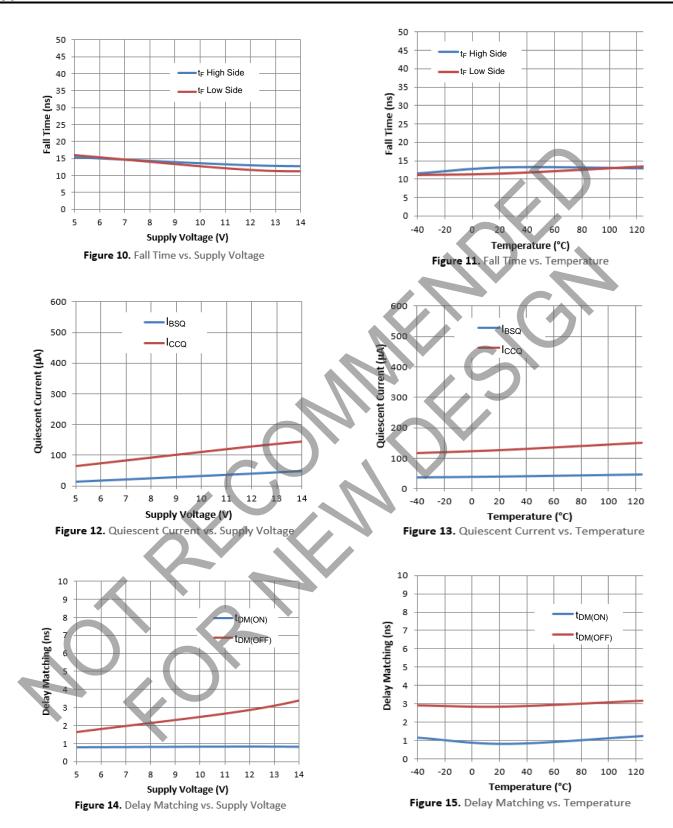






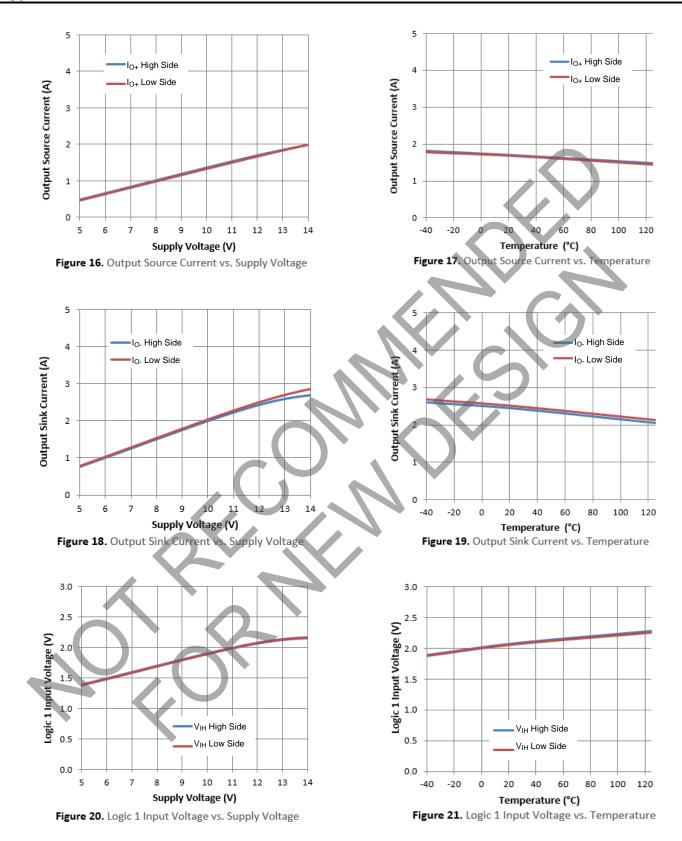


Typical Performance Characteristics (continued)



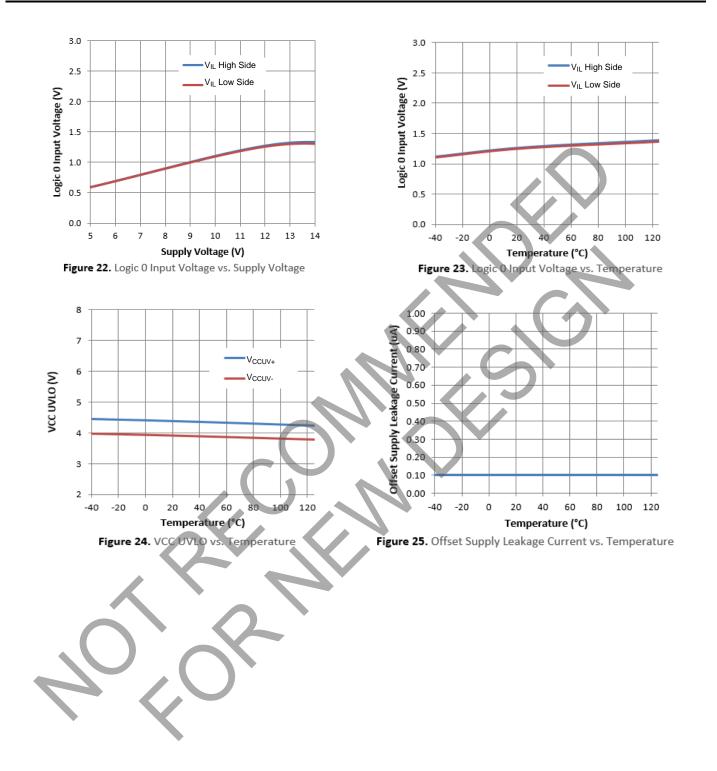


Typical Performance Characteristics (continued)





Typical Performance Characteristics (continued)

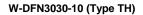


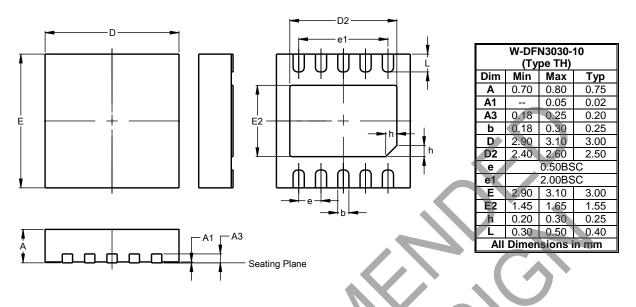


DGD0547

Package Outline Dimensions

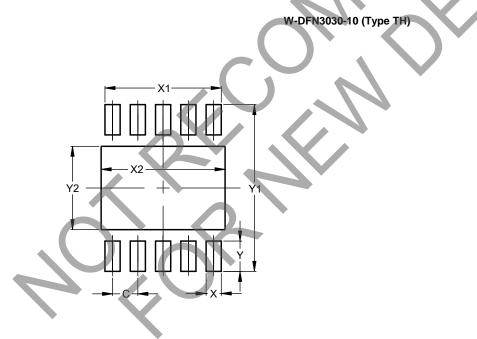
Please see http://www.diodes.com/package-outlines.html for the latest version.





Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.500
Х	0.300
X1	2.300
X2	2.600
Y	0.600
Y1	3.300
Y2	1.650



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